

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	768	257/67-70.ccls.	US-PGPUB; USPAT	OR	OFF	2006/03/07 13:46
L2	56	1 and ((adhe\$8 affinity bond\$6) near2 (semiconductor amorphous polycrystalline polysilicon "poly-si"))	US-PGPUB; USPAT	OR	ON	2006/03/07 14:48
L3	1	"6429070".pn.	US-PGPUB; USPAT	OR	OFF	2006/03/07 14:48
L4	1537	(substrate wafer integrated semiconductor silicon pcb pwb ((circuit wiring) adj board)) and (adhe\$8 with (semiconductor amorphous polycrystalline polysilicon)) and ((tft (thin adj film) piezoelectric (hall adj element) (light near (emit\$6 sens\$6))) with (semiconductor device silicon))	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 16:08
L5	4	L4 and (optical adj print\$6 adj head)	EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/03/07 16:08
L6	1800	(substrate wafer integrated semiconductor silicon pcb pwb ((circuit wiring) adj board)) same (adhe\$8 with (semiconductor amorphous polycrystalline polysilicon)) same ((tft (thin adj film) piezoelectric (hall adj element) (light near (emit\$6 sens\$6))) with (semiconductor device silicon))	US-PGPUB; USPAT	OR	ON	2006/03/07 16:13
L7	3	L6 and (optical adj print\$6 adj head)	US-PGPUB; USPAT	OR	ON	2006/03/07 16:13
L8	7028	257/81.ccls. 257/82.ccls. 257/84.ccls. 257/93.ccls. 257/98.ccls. 257/99.ccls. 257/693.ccls. 257/700.ccls. 257/701.ccls. 257/783.ccls.	US-PGPUB; USPAT	OR	ON	2006/03/07 16:16
L9	173	L6 and L8	US-PGPUB; USPAT	OR	ON	2006/03/07 16:16

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L10	115	(substrate wafer integrated semiconductor silicon pcb pwb ((circuit wiring) adj board)) with (adhe\$8 near2 (semiconductor amorphous polycrystalline polysilicon)) with ((tft (thin adj film) piezoelectric (hall adj element) (light near (emit\$6 sens\$6))) near2 (semiconductor device silicon))	US-PGPUB; USPAT	OR	ON	2006/03/07 16:40
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